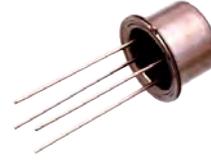


### Features

- Round Crystal Mounted at 4 Points
- Ultra High Shock & Vibration Design
- Hermetically Sealed, Cold Weld, Metal Package
- 100% Screening per MIL-PRF-3098, Class B
- Made in USA, ECCN: EAR99

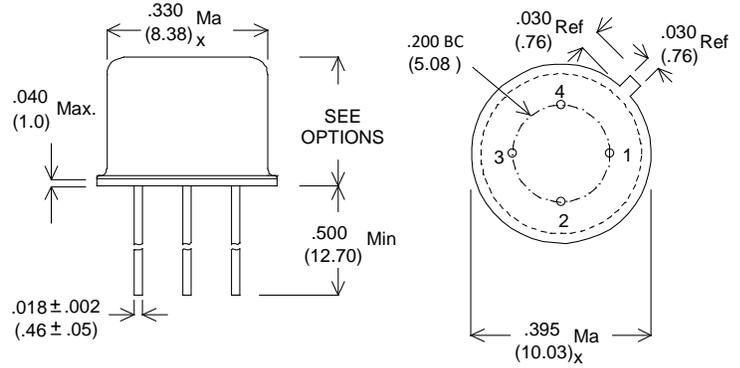


### Applications

- High Shock & Vibration Applications
- Navigation Systems
- Aerospace Instrumentation
- Digital Signal Processing
- Gun Launched Munitions

### Package Specifications & Outline:

- Cover Material: OFHC Copper
- Cover Finish: 100 to 200 microinches Electroless Nickel
- Lead Material: Kovar
- Lead Finish: 6 -15 micro-inches gold over 100 microinches Min. Nickel
- Base Material: 30/70 Copper Clad Kovar
- Base Finish: 6 -15 microinches gold over 100 microinches Min. Nickel
- Weight: 1.2g Typical, 1.5g Max



PIN #	FUNCTION
1	CRYSTAL
3	CRYSTAL
2 & 4	N/C

Hot Solder Tinning per MIL-PRF-55310 is optional at additional cost.

Contact Xsis Electronics at [xisis@xisis.com](mailto:xisis@xisis.com) for any special requirements.

### ORDERING INFORMATION ( Please build your part number from options below ) :

**P/N EXAMPLE:** XCR350 -1F6 - 24M00000 = 24.000 MHz, Fundamental Mode, 20 PF Load Capacitance, Frequency Accuracy of ± 50 PPM over -55°C to +125°C

<b>XCR</b>	<b>350</b>	-	<b>1</b>	<b>F</b>	<b>6</b>	- Frequency
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Package Options	Package Height
350	0.265" Max
351	0.220" Max
352	0.208" Max

Mode
1 = Fundamental
3 = 3 <sup>rd</sup> Overtone
5 = 5 <sup>th</sup> Overtone

Load Capacitance Options
R = Series
A = 8 pF
B = 10 pF
C = 12 pF
D = 15 pF
E = 18 pF
F = 20 pF
G = 25 pF
H = 30 pF
Z = Custom

Frequency Accuracy Options	
1 = ± 10 PPM	0°C to +50°C
2 = ± 20 PPM	-10°C to +70°C
3 = ± 20 PPM	-40°C to +85°C
4 = ± 50 PPM	-40°C to +85°C
5 = ± 25 PPM	-55°C to +105°C
6 = ± 50 PPM	-55°C to +125°C
7 = ± 75 PPM	-55°C to +125°C

**For special requirements, please contact Xsis Electronics at [xisis@xisis.com](mailto:xisis@xisis.com) or call us at 913-631-0448.**

**Table I - Electrical Specifications, Fundamental, 3rd and 5th Overtone Oscillation modes**

Parameter	Fundamental	3 <sup>rd</sup>	5 <sup>th</sup>
Nominal Frequency Range	6.4 MHz to 40.0 MHz	40.0 MHz to 150.0 MHz	75.0 MHz to 200.0 MHz
Mode	Fundamental	3 <sup>rd</sup>	5 <sup>th</sup>
Resonance Type	See Ordering Information		
Load Capacitance	See Ordering Information		
Frequency Accuracy Vs. Temperature	See Ordering Information		
Resistance ( ESR ) 6.4 to 20 MHz 20.1 to 40 MHz  40.0 to 90 MHz 90.1 to 150 MHz  75.0 to 125 MHz 125.1 to 200 MHz	40 Ohms Max. 30 Ohms Max.	50 Ohms Max 60 Ohms Max.	70 Ohms Max. 80 Ohms Max.
Shunt Capacitance	7 pF Max.		
Unwanted Modes Resistance	> 2 times the Main Mode Resistance		
Storage Temperature	-55 °C to +125 °C		
Drive Level	50 µW Typical, 1 mW Max.		
Aging at 25°C per year	± 3 PPM Max		

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**Table II - Environmental Specifications :**

Crystal Units shall be able to withstand any of the following environmental stresses with change in Frequency of less than 5 PPM and change in resistance of less than 10%.

Test - Inspection	Test Method - Condition
Shock	MIL-STD-202, Method 213, Cond. C
Vibration	MIL-STD-202, Method 204, Cond. A, 3 hours minimum.
Thermal Shock	MIL-STD-202, Method 107, Cond. B
Moisture Resistance	MIL-STD-202, Method 106, except Step 7b, Vibration, is not applicable.

**Table III - 100% Screening per MIL-PRF-3098, Class B**

Test - Inspection	Test Method – Condition
Pre-seal Visual Examination	MIL-PRF-3098, Method 4.10.2.2
Stabilization Bake ( Prior to Seal )	MIL-STD-883, Method 1008, Condition C ( +150 °C ), 24 hours minimum
Seal ( Fine and Gross Leak )	MIL-PRF-3098, Para. 4.10.26
Frequency and Resistance over Operating Temperature	MIL-PRF-3098, Para. 4.10.18
External Visual & Mechanical	MIL-PRF-3098, Para. 4.10.2.1

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**Table IV - Environmental**

XCR35x series crystal units are designed to meet or exceed the Environmental tests specified below. Customized screening and environmental testing are also available to meet your special requirements.

Test	Test Conditions
Mechanical Shock:	3000G, 0.5 mS shock.
Vibration, Random:	20G RMS, 10 Hz to 2000 Hz
Thermal Shock:	MIL-STD-202, Method 107, Condition B
Temperature Cycle:	MIL-STD-883, Method, 1010, Condition B
Moisture Resistance:	MIL-STD-202, Method 106
Salt Atmosphere:	MIL-STD-202, Method 101
Acceleration:	MIL-STD-883, Method 2002, Condition A, 5000G
Terminal Strength:	MIL-STD-202, Method 211 ( 2 lbs )
Fine Leak:	MIL-STD-202, Method 112, Condition C-IIIc (1x10 <sup>-8</sup> atm-cc/sec)
Gross Leak:	MIL-STD-202, Method 112, Condition D
Solderability:	MIL-STD-202, Method 208 ( ANSI-EIA-J-STD-002 )
Resistance to Soldering Heat:	MIL-STD-202, Method 210, Condition B or C
Resistance to Solvents:	MIL-STD-202, Method 215
Low Temperature Storage:	MIL-PRF-3098